Keysight Technologies

 EXG X-Series Signal Generators

 N5171B Analog & N5172B Vector

 9 kHz to 1, 3, or 6 GHz

 Data Sheet





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Definitions and Conditions

Specifications represent warranted performance of a calibrated instrument that has been stored for a minimum of 2 hours within the operating temperature range of 0 to 55 °C, unless otherwise stated, and after a 45 minute warm-up period. The specifications include measurement uncertainty. Data represented in this document are specifications unless otherwise noted.

Typical (typ) describes additional product performance information that is not covered by the product warranty. It is performance beyond specifications that 80 percent of the units exhibit with a 90 percent confidence level at room temperature (approximately 25 °C). Typical performance does not include measurement uncertainty.

Nominal (nom) values indicate the expect mean or average performance, or an attribute whose performance is by design, such as the 50 ohm connector. This data is not warranted and is measured at room temperature (approximately 25 °C).

Measured (meas) describes an attribute measured during the design phase for purposes of communicating expected performance, such as amplitude drift vs. time. This data is not warranted and is measured at room temperature (approximately 25 °C).

Optimized for manufacturing

On the path to faster throughput and greater uptime, the cost-effective Keysight Technologies, Inc. EXG X-Series signal generators are optimized for manufacturing test. With analog and vector models, the EXG provides the signals you'll need for basic parametric testing of components and functional verification of receivers. Get "just enough" test at the right price with the EXG.

Frequency Specifications

Frequency range			
Frequency range	Option 501 (N5171B only)	9 kHz to 1 GHz	
	Option 503	9 kHz (5 MHz IQ mode) to 3 GHz	7
	Option 506	9 kHz (5 MHz IQ mode) to 6 GHz	7
Resolution	0.001 Hz		
Phase offset	Adjustable in nominal 0.1 ° incre	ments	
Frequency bands ¹			
	Band	Frequency range	Ν
	1	9 kHz to < 5 MHz	Digital synthesis
	1	5 to < 250 MHz	1
	2	250 to < 375 MHz	0.25
	3	375 to < 750 MHz	0.5
	4	750 to < 1500 MHz	1
	5	1500 to < 3000.001 MHz	2
	6	3000.001 to 6000 MHz	4
Frequency switching speed ^{2,3}	3		
	Standard	Option UNZ ⁴	Option UNZ, typical
CW mode			
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 950 μs
List/step sweep mode	≤ 5 ms, typical	≤ 900 μs	≤ 800 μs
Digital modulation on (N5172	B only)		
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 1.05 ms
List/step sweep mode	≤ 5 ms, typical	≤ 900 μs	≤ 800 μs

N is a factor used to help define certain specifications within the document. 1.

Time from receipt of SCPI command or trigger signal to within 0.1 ppm of final frequency or within 100 Hz, whichever is greater, and amplitude settled to within 0.2 dB from 20 to 30 °C. When switching into or out of band 6 amplitude settling time is within 0.3 dB. Implies simultaneous frequency and 2. amplitude switching.

With internal channel corrections on, the frequency switching speed is < 1.3 ms, measured for list mode and SCPI mode cached frequency points. For the З. initial frequency point in SCPI mode the time is < 3.3 ms, measured. The instrument will automatically cache the most recently used 1024 frequencies. There is no speed degradation for amplitude-only changes. Specifications apply when status register updates are off. For export control purposes CW switching speed to within 0.05% of final frequency is

4. 190 µs (measured).

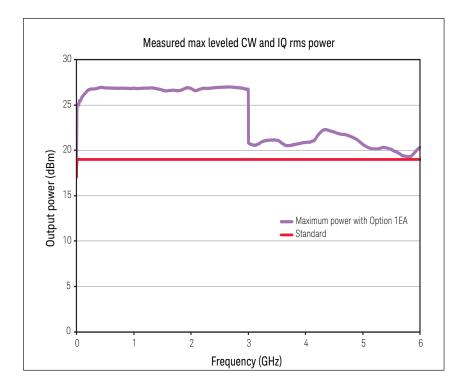
Frequency reference	
Accuracy	± (time since last adjustment x aging rate) ± temperature effects ± line voltage effects ± calibration accuracy
Internal time base reference oscillator aging rate ¹	≤ ± 5 ppm/10 yrs, < ± 1 ppm/yr
Initial achievable calibration accuracy	± 4 x 10 ⁻⁸ or ± 40 ppb
Adjustment resolution	< 1 x 10 ⁻¹⁰
Temperature effects	± 1 ppm (0 to 55 °C), nominal
Line voltage effects	± 0.1 ppm, nominal; 5% to –10%, nominal
Reference output	
Frequency	10 MHz
Amplitude	\geq +4 dBm, nominal into 50 Ω load
External reference input	
Input frequency, standard	10 MHz
Input frequency, Option 1ER	1 to 50 MHz (in multiples of 0.1 Hz)
Stability	Follows the stability of external reference input signal
Lock range	± 1 ppm
Amplitude	> -3.0 to 20 dBm, nominal
Impedance	50 Ω, nominal
Waveform	Sine or square
Sweep modes (frequency and amplitude)	
Operating modes	Step sweep (equally spaced frequency and amplitude or logarithmically spaced frequency steps) List sweep (arbitrary list of frequency and amplitude steps) Simultaneously sweep waveforms with N5172B; see Baseband Generator section for more detail
Sweep range	Within instrument frequency range
Dwell time	100 µs to 100 s
Number of points	2 to 65535 (step sweep) 1 to 3201 (list sweep)
Step change	Linear or logarithmic
Triggering	Free run, trigger key, external, timer, bus (GPIB, LAN, USB)

1. Not verified by Keysight N7800A TME Calibration and Adjustments Software. Daily aging rate may be verified as a supplementary chargeable service, on request.

Amplitude Specifications

Output parameters		
Settable range	+30 to -144 dBm	
Resolution	0.01 dB	
Step attenuator	0 to 130 dB in 5 dB s	steps electronic type
Connector	Type N 50 Ω, nomina	al
Max output power ¹ () = typical		
Frequency	Standard	Option 1EA
9 kHz to 10 MHz	+13 dBm	+17 dBm (+18 dBm)
> 10 MHz to 3 GHz	+18 dBm	+21 dBm (+26 dBm)
> 3 to 6 GHz	+16 dBm	+18 dBm (+19 dBm)

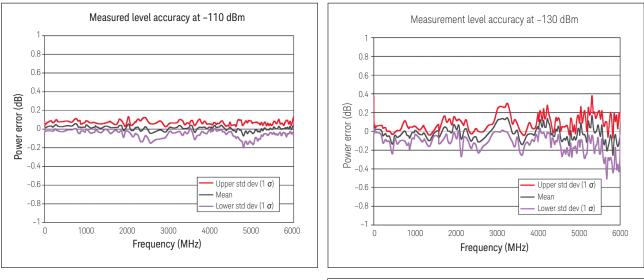
1. Quoted specifications between 20 °C and 30 °C. Maximum output power typically decreases by 0.01 dB/°C for temperatures outside this range.

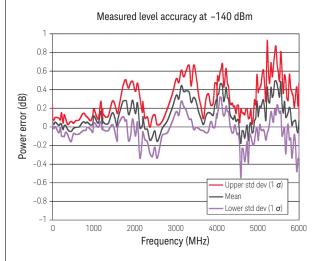


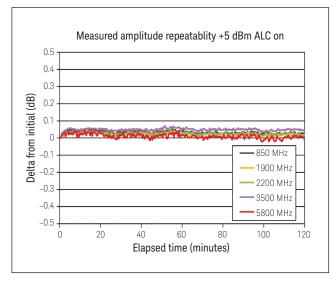
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Absolute level accuracy in CW mo	de ¹ (ALC on) ()= typical		
Range	Max power to -60 dBm	< -60 to -110 dBm	< -110 to -127 dBm
9 to 100 kHz	(± 0.6)	(± 0.9)	
100 kHz to 5 MHz	± 0.8 dB (± 0.3)	± 0.9 dB (± 0.3)	
> 5 MHz to 3 GHz	± 0.6 dB (± 0.3)	± 0.8 dB (± 0.3)	(± 0.5)
> 3 to 6 GHz	± 0.6 dB (± 0.3)	± 1.1 dB (± 0.3)	(± 0.6)
Absolute level accuracy in CW mo	de (ALC off, power search run, rela	tive to ALC on)	
9 kHz to 6 GHz	± 0.15 dB, typical		
Absolute level accuracy in digital	/Q mode (N5172B only)		
(ALC on, relative to CW, W-CDMA	1 DPCH configuration < +10 dBm)	
5 MHz to 6 GHz	± 0.25 dB, (0.05 dB)		

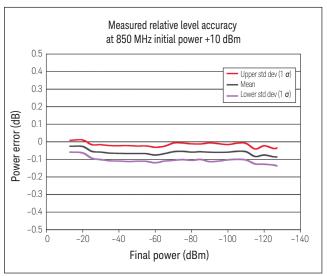
1. Quoted specifications between 20 °C and 30 °C. For temperatures outside this range, absolute level accuracy degrades by 0.01 dB/°C. Output power may drift up to 0.10 dB < 3 GHz and 0.15 dB > 3 GHz per g/kg change in absolute humidity (nom).



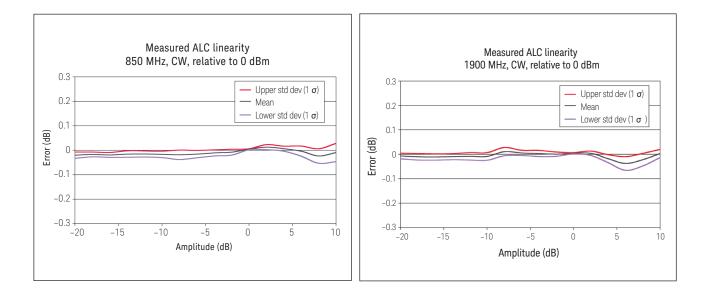




Repeatability measures the ability of the instrument to return to a given power setting after a random excursion to any other frequency and power setting. It should not be confused with absolute level accuracy.



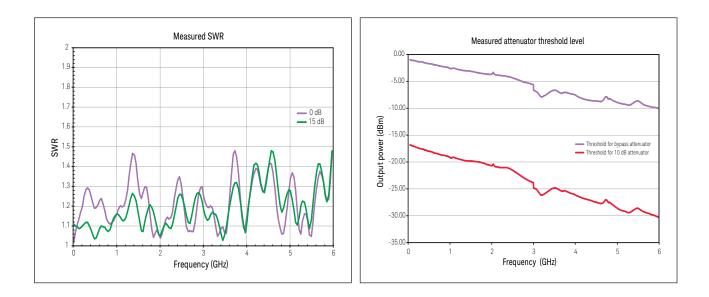
Relative level accuracy measures the accuracy of a step change from any power level to any other power level. This is useful for large changes (such as 5 dB steps).



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SWR (measured CW mode	e) ¹		
Frequency	Attenuator state		
	Bypass	0 to 10 dB	15 dB or more
≤ 1.0 GHz	< 1.3:1	< 1.35:1	< 1.2:1
> 1.0 to 2 GHz	< 1.55:1	< 1:5:1	< 1.3:1
> 2 to 3 GHz	< 1.8:1	< 1.5:1	< 1.45:1
> 3 to 4 GHz	< 1.5:1	< 1.6:1	< 1.7:1
> 4 to 6 GHz	< 1.9:1	< 1.6:1	< 1.6:1

1. SWR < 1.60:1 below 30 kHz.

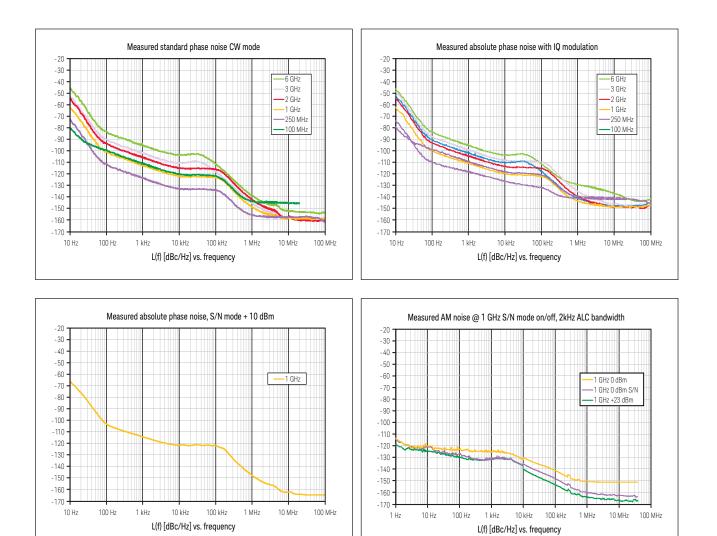


Maximum reverse power, nominal					
< 1 GHz	50 W				
> 1 to 2 GHz	25 W				
> 2 to 6 GHz	20 W				
Max DC voltage	50 VDC				
Trip level	2 W				
Amplitude switching speed ¹	Standard	Option UNZ	Option UNZ, typical		
CW mode					
SCPI mode	≤ 5 ms, typical	≤ 750 μs	≤ 650 μs		
Power search SCPI mode	< 12 ms, measured				
List/step sweep mode	≤ 5 ms, typical	≤ 500 μs	≤ 300 μs		
Digital modulation on (N5172B only)					
SCPI mode	≤ 5 ms, typical	≤ 1.15 ms	≤ 950 μs		
Power search SCPI mode	< 12 ms, measured				
List/step sweep mode	≤ 5 ms, typical	≤ 900 µs	≤ 400 μs		
Alternate power level control (N517	2B only)				
Switching time	20 μs within ± 1 dB, measure	ed			
(via waveform markers)					
Functional power range	–15 dBm to –144 dBm, mea	sured			
User flatness correction					
Number of points	3201				
Number of tables	Dependent on available free memory in instrument; 10,000 maximum				
Entry modes	USB/LAN direct power mete	USB/LAN direct power meter control, LAN to GPIB and USB to GPIB, remote bus and manual USB/GPIB power			
	meter control				
Sweep modes					
	See Frequency Specification	s section for more detail			

1. Time from receipt of SCPI command or trigger signal to amplitude settled within 0.2 dB. Switching speed specifications apply when status register updates are off.

Spectral Purity Specifications

Absolute SSB phase noise (dBc/Hz, CW at 20 kHz offset, typical)		
5 MHz to < 250 MHz	-119	
250 MHz	-133	
500 MHz	-128	
1 GHz	-122	
2 GHz	-115	
3 GHz	-110	
4 GHz	-109	
6 GHz	-103	



Residual FM (CW mode, 300 Hz	z to 3 kHz BW, CCITT, rms)		
5 MHz to 6 GHz	< N x 2 Hz (measured) (see N value	e in frequency band table)	
Residual AM (CW mode, 0.3 to	3 kHz BW, rms, +5 dBm)		
100 kHz to 3 GHz	< 0.01% (measured)		
Harmonics (CW mode)			
Range	Standard < +4 dBm	Option 1EA < +12 dBm	
9 kHz to 3 GHz	< -35 dBc	< -30 dBc	
> 3 to 4 GHz	< –35 dBc, typical	< –35 dBc, typical	
> 4 to 6 GHz	< –53 dBc, typical	< -40 dBc, typical	
Nonharmonics (CW mode)			
Range	> 10 KHz offset		
	Standard (dBc)		
9 kHz to < 5 MHz	–65, nominal		
5 to < 250 MHz	-75		
250 to < 750 MHz	-75		
750 MHz to < 1.5 GHz	-72		
1.5 to < 3.0 GHz	-66		
3 to 6 GHz	-60		

Subharmonics (CW mode)				
9 kHz to 1.5 GHz	None			
> 1.5 to 3 GHz	-77 dBc			
> 3 to 6 GHz	-74 dBc			
Jitter ¹				
Carrier frequency	SONET/SDH data rate	rms jitter BW	μUI rms, measured	Seconds, typical
155 MHz	155 MB/s	100 Hz to 1.5 MHz	140	0.9 ps
622 MHz	622 MB/s	1 KHz to 5 MHz	67	0.11 ps
2.488 GHz	2488 MB/s	5 kHz to 20 MHz	271	0.11 ps
Phase coherence (Option 012)				
LO input frequency range	250 MHz to 6 GHz, nomir	nal		
LO input power range	0 to +12 dBm, nominal			
LO output frequency range	250 MHz to 6 GHz, nomir	nal		
LO output power range	0 to +12 dBm, nominal			

1. Calculated from phase noise performance in CW mode at +10 dBm. For other frequencies, data rates, or bandwidths, please consult your sales representative.

Analog Modulation Specifications

Band #	Frequency range	Ν	
1	9 kHz to < 5 MHz	1 (digital synthesis)	
1	5 to < 250 MHz	1	
2	250 to < 375 MHz	0.25	
3	375 to < 750 MHz	0.5	
4	750 to < 1500 MHz	1	
5	1500 to < 3000.001 MHz	2	
6	3000.001 to 6000 MHz	4	
Frequency modulation (Option UNT) (See N value above)		
Max deviation	N × 10 MHz, nominal ³		
Resolution	1 Hz, nominal		
Deviation accuracy	< ± 2% + 20 Hz (1 kHz rate, deviation is N x	50 kHz)	
Modulation frequency response	1 dB bandwidth	DC/5 Hz to 3 MHz, nominal	
@ 100 kHz deviation	3 dB bandwidth	DC/1 Hz to 7 MHz, nominal	
Carrier frequency accuracy	$< \pm 0.2\%$ of set deviation + (N × 1 Hz) ¹		
Relative to CW in DCFM	< ± 0.06% of set deviation + (N × 1 Hz), typ	ical ²	
Total harmonic distortion	< 0.4% [1 kHz rate, deviation is N x 50 kHz]		
FM using external inputs 1 or 2	Sensitivity	+1 V peak for indicated deviation, nominal	
	Input impedance	50 Ω/600 Ω/1 M Ω, nominal	
	Paths	FM path 1 and FM path 2 are summed internally for composite modulation	
Phase modulation (Option UNT) (See N	N value above)		
Maximum deviation	Normal bandwidth	N × 5 radians, nominal	
	High-bandwidth mode	N × 0.5 radians, nominal	
Frequency response	Normal bandwidth (3 dB)	DC to 1 MHz, nominal	
	High-bandwidth mode (3 dB)	DC to 4 MHz, nominal	
Resolution	0.1% of deviation		
Deviation accuracy	< + 0.5% + 0.01 rad, typical [1 kHz rate, no	rmal bandwidth mode]	
Total harmonic distortion	< 0.2% (typ) [1 kHz rate, N x 1 radian deviat	ion normal bandwidth mode]	
Φ M using external inputs 1 or 2	Sensitivity	+1 V peak for indicated deviation, nominal	
	Input impedance	50 Ω or 600 Ω or 1 M $\Omega,$ nominal	
	Paths	Φ M path 1 and Φ M path 2 are summed internally for composite modulation	

Specification valid for temperature changes of less than ± 5 °C since last DCFM calibration.
 Typical performance immediately after a DCFM calibration.
 Digital synthesis band FM deviation is 5 MHz.

AM depth type	Linear or expon	ential					
Maximum depth	100%						
Depth resolution	0.1% of depth (nom)						
AM depth error	f < 5 MHz		< 1.5% of set	ting + 1% (typ 0.5%	of setting + 1%)		
@1 KHz rate and < 80% depth	5 MHz ≤ f ≤ 2 G	Hz	< 3% of settir	ng + 1 %			
	2 < f < 3 GHz		< 5% of settir	ng + 1% (typical 3%	of setting + 1%)		
Total harmonic distortion			30% depth	< 0.25%, typ	ical		
@ 1 KHz rate	F < 5 MHz		80% depth	< 0.5%, typic	cal		
	5 MHz ≤ f < 2 G (2 to 3 GHz is ty		30% depth	< 2%			
			80% depth	< 2%			
Frequency response	30% depth, 3 d	BBW	DC/10 Hz to S	50 KHz			
Frequency response wideband AM (N5172B only)	Rates ALC off/c	in:	DC/800 Hz to	DC/800 Hz to 80 MHz, nominal			
AM inputs using external inputs	Sensitivity	+1 V peak for indicated depth (Over-range can be 200% or 2.2 V pe			6 or 2.2 V peak)		
or 2	Input impedanc	Input impedance 50Ω or 600Ω or $1M \Omega$, Damage level: ± 5 V max					
	Paths		AM path 1 an	d AM path 2 are su	AM path 2 are summed internally for composite modulatio		
Wideband AM inputs	Sensitivity		0.25 V = 100% (I input + 0.5 V offset)				
(N5172B only)	Input impedance	e	50 Ω, nomina	50 Ω, nominal (I input)			
Simultaneous and composite modu	ulation ²						
Simultaneous modulation	phase modulati same modulatio	on cannot be co on source; for e	ombined and two mode	ulation types canno I/Q generator, AM,	imultaneously enabled It be simultaneously ge and FM can run concur	nerated using the	
Composite modulation			of two modulation pat ation of internal or ext		ed internally for compo	site modulation;	
	AM	FM	Phase	Pulse	Internal I/Q ²	External I/Q ²	
AM	+	+	+	+	+	+	
M	+	+	-	+	+	+	
Phase	+	-	+	+	+	+	
Pulse	+	+	+	-	+	+	
					*	-	
nternal I/Q ²	+	+	+	+	Tr.	+	

AM specifications apply 6 dB below maximum specified power from 20 to 30 °C.
 I/Q modulation available on N5172B.

External modulation inputs			
(Option UNT required for FM, AM, and phase modu	lation inputs; Option UNW required for pulse modulation inputs)		
EXT1	AM, FM, PM		
EXT2	AM, FM, PM		
PULSE	Pulse (50 Ω only)		
1	Wideband AM (50 Ω only, N5172B only)		
Input impedance	50 Ω, 1 MΩ, 600 Ω, DC and AC coupled		
Standard internal analog modulation source			
(Single sine wave generator for use with AM, FM,	phase modulation requires Option UNT or 303)		
Waveform	Sine, square, triangle, positive ramp, negative ramp		
Rate range	0.1 Hz to 2 MHz (tunable to 3 MHz)		
Resolution	0.1 Hz		
Frequency accuracy	Same as RF reference source, nominal		
LF audio output	O to 5 V peak into 50 $\Omega,$ –5 V to 5 V offset, nominal		
Multifunction generator (Option 303)			
The multifunction generator option (Option 303) con using the composite modulation features in AM, FM	nsists of seven waveform generators that can be set independently with up to five simultaneously /PM, and LF out		
Waveform			
Function generator 1	Sine, triangle, square, positive ramp, negative ramp, pulse		
Function generator 2	Sine, triangle, square, positive ramp, negative ramp, pulse		
Dual function generator	Sine, triangle, square, positive ramp, negative ramp, phase offset, and amplitude ratio for Tone 2 relative to Tone 1		
Swept function generator	Sine, triangle, square, positive ramp, negative ramp Trigger: free run, trigger key, bus, external, internal, timer trigger		
Noise generator 1	Uniform, Gaussian		
Noise generator 2	Uniform, Gaussian		
DC	Only for LF output –5 V to +5 V, nominal		
Frequency parameters			
Sine wave	0.1 Hz to 10 MHz, nominal		
Triangle, square, ramp, pulse	0.1 Hz to 1 MHz, nominal		
Noise bandwidth	10 MHz, nominal		
Resolution	0.1 Hz		
Frequency accuracy	Same as RF reference source, nominal		
Narrow pulse modulation (Option UNW) ¹ () = typica			
On/off ratio	(> 80 dB)		
Rise/fall times (Tr, Tf)	< 10 ns; (7 ns)		
Minimum pulse width ALC on/off	≥ 2 us/≥ 20 ns		
Repetition frequency ALC on/off	10 Hz to 500 kHz/DC to 10 MHz		
Level accuracy (relative to CW) ALC on/off ²	<pre>< ± 1.0 dB (± 0.5) dB/(< ± 0.5) dB</pre>		
Width compression (RF width relative to video out)			

Pulse specifications apply to frequencies > 100 MHz and power set to > -3 dBm. Operable down to 9 kHz.
 With power search on.

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Video feed-through ¹ ≤ 3 GHz/> 3 GHz	(< 50 mV/< 5 mV)
External video delay (ext input to video)	30 ns, nominal
RF delay (video to RF output)	20 ns, nominal
Pulse overshoot	(< 15%)
Input level	+1 Vpeak = RF on into 50 Ω, nominal
T _d video delay (variable)	

T_w video pulse width (variable)

T_p pulse period (variable)

T_m RF delay

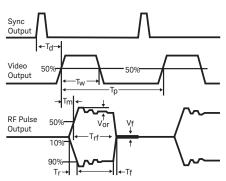
T_{rf} RF pulse width

T_f RF pulse fall time

T, RF pulse rise time

V_{or} pulse overshoot

V_f Video feedthrough



Internal pulse generator (included with Option UNW)				
Modes	Free-run, square, tri	Free-run, square, triggered, adjustable doublet, trigger doublet, gated, and external pulse		
Square wave rate	0.1 Hz to 10 MHz, 0.1	Hz resolution, nominal		
Pulse period	30 ns to 42 seconds,	nominal		
Pulse width	20 ns to pulse period	I –10 ns, nominal		
Resolution	10 ns			
Adjustable trigger delay	(–pulse period + 10 r	(-pulse period + 10 ns) to (pulse width –10 ns)		
Settable delay	Free run	-3.99 to 3.97 μs		
	Triggered	0 to 40 s		
Resolution (delay, width, period)	10 ns, nominal			
Pulse doublets	1st pulse delay	(Relative to sync out) 0 to 42 s – pulse width – 10 ns		
	1st pulse width	500 ns to 42 s – delay – 10 ns		
	2nd pulse delay	0 to 42 s – (Delay 1 + Width 2) – 10 ns		
	2nd pulse width	20 ns to 42 s – (Delay 1 + Delay 2) – 10 ns		
Pulse train generator Option 320 (requires Option UNW)				

Number of pulse patterns	2047
On/off time range	20 ns to 42 sec

FREQUENCY ATTIPLITUDE 6.000 000 000 000 GHz -10.00 dBm	Train Display Time Offset 0.00000000 sec
Time Offset: 0.000 000 00 Sec Pulse Train	Zoom In
	Zoom Out
0sec 1.00usec/div 4.30usec	Zoom In Max
	Zoom Out Max
*** PROTO CODE ** NOT FOR CUSTOMER USE *** 05/19/2010 09:41	

1. Video feed through applies to power levels < +10 dBm.

Avionics (Option 302)			
VOR			
Bearing accuracy		± 0.1 degrees	
Frequency accuracy		Same as RF reference source, nominal	
AM accuracy	30% depth	± 5% of setting	
AM distortion		2%	
FM accuracy	480 Hz deviation	± 1.7 Hz	
ILS: localizer and glide slope			
AM accuracy	40% depth	± 5% of setting	
AM distortion		2%	
Difference in depth of modulation (DDM) resolution	Localizer	0.0002	
	Glide slope	0.0004	
Difference in depth of modulation (DDM)	Localizer	$\pm 0.0004 \pm 5\%$ of DDM ¹	
accuracy	Glide slope	$\pm 0.0008 \pm 5\%$ of DDM ¹	
Marker beacon			
Marker tone AM accuracy	95% depth	± 5% of setting + 1%	
Marker tone AM distortion	95% depth	5%	

1. DDM must not be equal to 0.

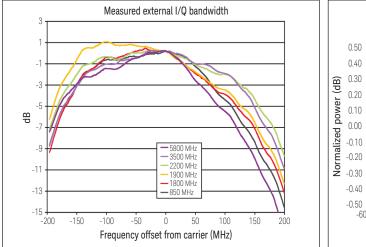
Vector Modulation Specifications

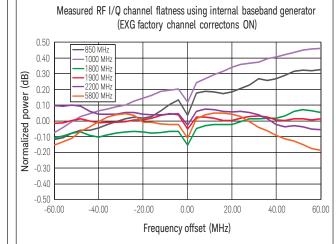
N5172B only

I/Q modulator external inputs ¹				
Bandwidth	Baseband (I or Q)	Up to 100 MHz baseband, nominal		
	RF (I+Q)	Up to 200 MHz RF, nominal		
l or Q offset	± 100 mV (200 uV resolution	n)		
I/Q gain balance	± 4 dB (0.001 dB resolutio	n)		
I/Q attenuation	0 to 50 dB (0.01 dB resolu	tion)		
Quadrature angle adjustment	± 200 units			
Full scale input drive (I+Q)	0.5 V into 50 Ω, nominal			
Internal I/Q baseband generator adju	istments ^{1,2} (Options 653 and 655)			
I/Q offset	± 20%	(0.025% dB resolution)		
I/Q gain	± 1 dB	(0.001 dB resolution)		
Quadrature angle adjustment	± 10 °	(0.01 degrees resolution)		
I/Q phase	± 360.00 °	(0.01 degrees resolution)		
I/Q skew	± 500 ns	(1 picosecond resolution)		
I/Q delay	± 250 ns	(1 picosecond resolution)		
External I/Q outputs ¹				
Impedance	50 Ω , nominal per output	50 Ω, nominal per output		
	100 Ω , nominal differentia	100 Ω , nominal differential output		
Туре	Single-ended or differentia	Single-ended or differential (Option 1EL)		
Maximum voltage per output	1 V peak-to-peak or 0.5 V	1 V peak-to-peak or 0.5 V peak; into 50 Ω (200 uV resolution)		
Bandwidth (I, Q)	Baseband (I or Q)	60 MHz, nominal (Option 653 and 655)		
	RF (I+Q)	120 MHz, nominal (Option 653 and 655)		
Amplitude flatness	± 0.2 dB measured with ch	\pm 0.2 dB measured with channel corrections optimized for I/Q output		
Phase flatness	± 2.5 degrees measured w	± 2.5 degrees measured with channel corrections optimized for I/Q output		
Common mode I/Q offset	± 1.5 V into 50 Ω (200 uV r	± 1.5 V into 50 Ω (200 uV resolution)		
Differential mode I or Q offset	± 50 mV into 50 Ω (200 uV	\pm 50 mV into 50 Ω (200 uV resolution)		

1. I/Q adjustments represent user interface nominal parameter ranges and not specifications.

2. Internal I/Q adjustments apply to RF out and I/Q outputs simultaneously.





Internal real-time complex digital I/Q filters (included with Option 653)

Factory channel correction (256 taps)

Corrects the linear phase and amplitude response of the baseband I/Q and RF outputs of the signal generator using factory calibration arrays (default mode is off).

RF amplitude flatness (120 MHz)	± 0.2 dB measured
RF phase flatness (120 MHz)	± 2 degrees measured

User channel correction (256 taps)

Automated routine uses USB power sensor to correct for linear phase and amplitude response of DUT (equalizer). See User Guide for more details.

Max RF amplitude flatness correction	± 15 dB
Max RF phase flatness correction	± 20 degrees

Equalization filter (256 taps)

User can download and apply inverse or custom phase and amplitude response coefficients from tools such as MATLAB, 89600 VSA, or SystemVue to correct for linear errors of DUT/system. See User Guide for more details.

Baseband generator (Options 653 and 65	5)		
Channels	2 [l and Q]		
Resolution	16 bits [1/65,536]		
Sample rate	Option 653	100 Sa/s to 75 MSa/s	
	Option 653 and 655	100 Sa/s to 150 MSa/s	
RF (I+Q) bandwidth	Option 653	60 MHz, nominal	
	Option 653 and 655	120 MHz, nominal	
Interpolated DAC rate	800 MHz (waveforms only need OSR = 1.2	5)	
Frequency offset range	± 60 MHz		
Digital sweep modes	In list sweep mode each point in the list can have independent waveforms (N5172B) along with user definable frequencies and amplitudes; see the Amplitude and Frequency Specifications sections for more detail.		
Waveform switching speed ¹	SCPI mode	≤ 5 ms, measured (standard)	
		\leq 1.2 ms, measured (Option UNZ)	
	List/step sweep mode	≤ 5 ms, measured (standard)	
		\leq 900 us, measured (Option UNZ)	
Waveform transfer rates (measured, no markers, unencrypted)	FTP LAN to internal SSD	10.7 MB/sec or 2.67 Msa/sec	
	Internal SSD to FTP LAN	7.7 MB/sec 1.92 Msa/sec	
	FTP LAN to BBG	8.2 MB/sec or 2.05 Msa/sec	
	FTP LAN to BBG encrypted	4 MB/sec or 1 Msa/sec	
	USB to BBG	19 MB/sec or 4.75 Msa/sec	
	BBG to USB	1.2 MB/sec or 300 Ksa/sec	
	Internal SSD to BBG	48 MB/sec or 12 Msa/sec	
	BBG to internal SSD	1.2 MB/sec or 300 Ksa/sec	
	SD card to BBG (Option 006)		
	BBG to SD card (Option 006)	845 KB/sec or 211 Ksa/sec	

1. SCPI mode switching speed applies when waveforms are pre-loaded in list sweep and sample rate \ge 10 MSa/s.

		00.14 (1 1 1)	
Arbitrary waveform memory	Maximum playback	32 Msa (standard)	<u>\</u>
	capacity	256 Msa (Option 021)	
		512 Msa (Option 022	
	Maximum storage	3 GBytes/800 Msa (s	
	capacity including markers	30 GBytes/7.5 Gsa (Option 009)	
		8 GBytes / 2 Gsa (Option 006)	
Waveform segments		60 samples to 32 Ms	a (standard)
	Segment length	60 samples to 256 Msa (Option 021)	
		60 samples to 512 M	isa (Option 022)
	Minimum memory allocation per segment	256 samples	
	Maximum number of segments	8192	
Waveform sequences	Maximum number of sequences	> 2000 depending or	n non-volatile memory usage
	Maximum number of	32,000 (standard)	
	segments/sequence	4 million (Option 021	or 022)
	Maximum number of repetitions	65,535	
Triggers	Types		Continuous, single, gated, segment advance
	Source		Trigger key, external, bus (GPIB, LAN, USB)
	Modes	Continuous	Free run, trigger and run, reset and run
		Single	No retrigger, buffered trigger, restart on trigger
		Gated	Negative polarity or positive polarity
		Segment advance	Single or continuous
	External coarse delay tin	-	5 ns to 40 s
	External coarse delay resolution		5 ns
	Trigger latency (Single trigger only)		356 ns + 1 sample clock period, nominal
	Trigger accuracy (Single trigger only)		± 2.5 ns, nominal
	Single trigger - restart on trigger mode will initiate a FIFO clear. Therefore, the latency includes re-filling the		
	buffer. The latency is 8 μ	ıs + (1406 x sample per	riod) ± 1 sample clock period, nominal
Multi-baseband generator synchroniza-	Fan out		1 master and up to 15 slaves
tion mode (multiple sources)	Trigger repeatability		< 1 ns, nominal
	Trigger accuracy		Same as normal mode
	Trigger latency		Same as normal mode
	Fine trigger delay range		See Internal I/Q Baseband section
	Fine trigger delay resolution		See Internal I/Q Baseband section
	I/Q phase adjustment range		See Internal I/Q Baseband section
Markers	Markers are defined in a segment during th		aveform generation process, or from the front panel; a marker d functions, and alternate amplitude; see Users Guide for more
	Marker polarity		Negative, positive
	Number of markers		4
	RF blanking/burst on/off ratio		> 80 dB
	Alternate amplitude control switching speed		See amplitude section

Real-time modulation FIR filter:	Nyquist, root-Nyquist, WCDMA, EDGE, Gaussian, rectangular, APCO 25 C4FM, IS-95, User FIR (Applies real-time FIR filtering when playing waveforms with OSR=1. Helps reduce waveform size for long simulation times. Option 660 not required).	
Real-time baseband generator (Option 6	660)	
Real-time baseband generator required for real-time Signal Studio applications ¹	Cellular real-time applications	LTE-FDD, LTE-TDD, HSPA+/W-CDMA, GSM/EDGE, cdma2000®
	Real-time navigation	GPS, GLONASS, Galileo
	Real-time video applications	DVB-T/T2/H/S/S2/C/J.83 Annex A/C, ISDB-T/
	Note: Option 660 is not required for real-time custom modulation (Option 431)	
	Memory: Shares memory with Options 653 and 655	
	Triggering: Same as Options 653 and 655	
	Markers: 3 markers available, all other features are same as Options 653 and 655	

Digital baseband inputs/outputs (Option 003/004)

Options 003 and 004 activate the rear panel digital I/Q bus and enables connectivity to the N5102A digital signal interface module. In output mode (003), you can deliver realistic complex-modulated signals such as LTE, GPS, WLAN, custom pulses and many others directly to your digital devices and subsystems. In the input mode (004), the interface module ports your digital input to the signal generator's baseband system, providing a quick and easy way of upconverting to calibrated analog I/Q, IF, or RF frequencies. In both operating modes, the interface module adapts to your device with the logic type, data format, clock features, and signaling you require.

Data (requires N5102A)	
Digital data format	User-selectable: 2's complement or binary offset, I/Q (I, I-bar, Q, Q-bar) or digital IF output (real, imaginary)
Data port	Dual 16-bit data buses support parallel, parallel I/Q interleaved, parallel QI interleaved, or serial port configuration
N5102A connectors (breakout boards)	144-pin Tyco Z-Dok+ connects to break-out boards (included with N5102A) that interface with the following connector types: 68-pin SCSI, 38-pin dual AMP Mictor, 100-pin dual Samtec, 20-pin dual 0.1 inch headers, 40-pin dual 0.1 inch headers
Logic types	Single-ended: LVTTL, 1.5V CMOS, 1.8V CMOS, 2.5V CMOS, 3.3.V CMOS
	Differential: LVDS
Data output resampling	EXG baseband output is resampled to the arbitrary clock rate set by the user via real-time curve-fit calculations.

1. See www.keysight.com/find/signalstudio for more information.

Clock (requires N5102A)						
Clock input	User selectable: internal clock, device under test clock, or external clock (via SMA or breakout board)					
	N5102A SMA Ext Clock In connector: 50 Ω , 0 dBm nominal, 1 to 400 MHz					
Clock output	User selectable: via breakout boar	d or SMA Clock Out connector				
	N5102A SMA Clock Out connector 100 kHz to 400 MHz	r: 2 Vpp into load > 5 K Ω from 1 to 100 kHz, 400 mVpp into 50 Ω load from				
Sample rate (limited by EXG sample rate)		p to a maximum 150 MHz, but limited by other user settings (see N5102A				
	User-selectable in serial mode, the	e maximum rate is 400 MHz/word size.				
Bit rate (limited by EXG sample rate)	Parallel Up to 150 MHz x word size 2 parallel buses available	e (1.6 Gbps LVDS, CMOS and LVTTL) per parallel bus,				
	· · · · · · · · · · · · · · · · · · ·	e (400 Mbps LVDS) or 150 MHz per serial line (150 Mbps (CMOS/LVTTL) 32				
Clocks per sample	In parallel output mode, the data s	ample can be held for 1, 2 or 4 clock cycles				
Clock to data skew		om 0 to 270°; fine-adjustment in increments of 100 ps up to 5 ns				
Clock polarity	Clock signals may be inverted					
Frequency reference input	1 to 100 MHz BNC, 50 Ω , 3 dBm ± 6 dB,					
Power supply (included on N5102A)	Output: 5 V, 4 A DC	,				
AWGN (Option 403)						
Туре	Real-time, continuously calculated	d. and played using DSP				
Modes of operation		gnal played by arbitrary waveform or real-time baseband generator				
Bandwidth	With Option 653	1 Hz to 60 MHz				
	With Option 653 and 655	1 Hz to 120 MHz				
Crest factor	15 dB					
Randomness	90 bit pseudo-random generation	, repetition period 313 x 10 ⁹ years				
Carrier-to-noise ratio	± 100 dB when added to signal					
Carrier-to-noise ratio formats	C/N, Eb/No					
Carrier-to-noise ratio error	Magnitude error ≤ 0.2 dB at baseb	and I/Q outputs				
Custom modulation Arb Mode (Option	n 431)					
Modulation	PSK	BPSK, QPSK, OQPSK, π/4DQPSK, gray coded and unbalanced QPSK, 8PSK, 16PSK, D8PSK				
	QAM	4, 16, 32, 64, 128, 256, 1024 (and 89600 VSA mappings)				
	FSK	Selectable: 2, 4, 8, 16, C4FM				
	MSK	0 to 100°				
	ASK	0 to 100%				
Multicarrier	Number of carriers	Up to 100 (limited by a max bandwidth of 120 MHz depending on symbol rate and modulation type)				
	Frequency offset (per carrier)	Up to -60 to +60 MHz				
	Power offset (per carrier)	0 dB to -40 dB				
Symbol rate	50 sps to 75 Msps					
Filter types	Nyquist, root-Nyquist, Gaussian, r	ectangular, APCO 25 C4FM, user				
Quick setup modes	31 0 31 0 0	PSK, Bluetooth®, CDPD, DECT, EDGE, GSM, NADC, PDC, PHS, PWT, TETRA				
Data	Random only					

	mode (Option 431) (Does not require C						
Modulation	PSK		PSK, gray coded and unbalanced QPSK, 8PSK, S95 OQPSK, EDGE, HDQPSK, SOQPSK				
	QAM	4, 16, 32, 64, 128, 256, 1024	4, 16, 32, 64, 128, 256, 1024 (and 89600 VSA mappings)				
		Selectable	2,4,8, 16 level symmetric, C4FM, HCPM				
	FSK	User-defined	Custom map of up to 16 deviation levels				
		Max deviation	20 MHz				
	MSK	0 to 100°					
	ASK	0 to 100%					
	DVB-S2 APSK		APSK 4/5, 16APSK 5/6, 16APSK 8/9, 16APSK 4/5, 32APSK 5/6, 32APSK 8/9, 32APSK 9/10				
	Custom I/Q	Custom map of 1024 unique	values				
Frequency offset	Up to –60 MHz to +60 MHz						
Symbol rate	Internal generated data	1 sps to 75 Msps and max of	10 bits per symbol (Option 653 + 655)				
	External serial data	1 sps to [(50 Mbits/sec)/(#bit	s/symbol)]				
Filter types	Selectable	Nyquist, root-Nyquist, Gaussian, rectangular, APCO 25 (phase 1 and 2 UL and DL), IS-95, WCDMA, EDGE (wide and HSR)					
		IS-95 w/EQ, IS-95 Mod, IS-95 Mod w/EQ, HDQPSK, APCO25 HCPM, SOQPSK-TG					
	Custom FIR	 16-bit resolution, up to 64 symbols long, automatically resampled to 1024 coefficients (max) > 32 to 64 symbol filter: symbol rate ≤ 12.5 MHz > 16 to 32 symbol filter: symbol rate ≤ 25 MHz Internal filters switch to 16 tap when symbol rate is between 25 and 75 MHz 					
Quick setup modes		APCO 25 with (C4FM, CQPSK, HCPM, HDQPSK), TETRA , <i>Bluetooth</i> , CDPD, DECT, EDGE, GSM, NADC, PDC, PHS, PWT, WorldSpace, Iridium, ICO, CT2, TFTS					
		16APSK 2/3, 16APSK 3/4, 16APSK 4/5, 16APSK 5/6, 16APSK 8/9, 16APSK 9/10, 32APSK 3/4, 32APSK 4/5, 32APSK 5/6, 32APSK 8/9, 32APSK 9/10, SOQPSK					
Trigger delay	Range		0 to 1,048,575 bits				
	Resolution		1 bit				
Data types	late malls, as a sate of	Pseudo-random patterns	PN9, PN11, PN15, PN20, PN23				
	Internally generated	Repeating sequence	Any 4-bit sequence				
			32 Mb (standard)				
	Direct-pattern RAM [PRAM] Note: Used for custom TDN		512 Mb (Option 021)				
		in non-stanuaru Italinny	1024 Mb (Option 022)				
			32 MB (standard)				
	User file		256 MB (Option 021)				
			512 MB (Option 022)				
	Externally streamed data	Туре	Serial data				
	(via AUX I/O)	Inputs/outputs ¹	Data, symbol sync, bit clock				
Internal burst shape	Rise/fall time range		Up to 30 bits				
(varies with bit rate)	Rise/fall delay range		–15 to +15 bits				

1. Bit clock and symbol sync inputs will be available in future firmware release.

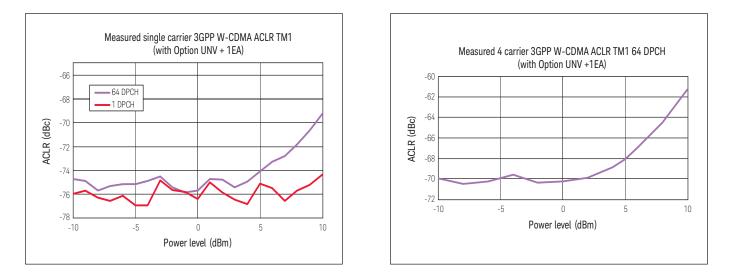
Multitone and two-tone (Option 430)					
Number of tones	2 to 512, with selectable of	2 to 512, with selectable on/off state per tone			
Frequency spacing	100 Hz to 120 MHz (with 0	100 Hz to 120 MHz (with Option 653 and 655)			
Phase (per tone)	Fixed or random	Fixed or random			
Real-time phase noise impairments (O	Real-time phase noise impairments (Option 432)				
Close-in phase noise characteristics	–20 dB per decade				
Far-out phase noise characteristics	–20 dB per decade				
Mid-frequency characteristics	Start frequency (f1)	Offset settable from 0 to 77 MHz			
	Stop frequency (f2)	Offset settable from 0 to 77 MHz			
Phase noise amplitude level (L(f))	User selected; max degradation dependent on f2				

FREQUENCY		ITUDE	Phase Noise
	000 000 00 GHz	-5.00 dBm	Phase Noise
Desired f1: 1.000 Standa	1000 kHz None Additive Phase Noise I	mpairment	Desired Start Freq(f1) 1.000000kHz
-40	f1 f2		Desired Stop Freq(f2) 30.000000kHz
L(f) dBc/Hz		Lmid	Desired Flat Amplitude(Lmid) -70.00 dBc/Hz
-110	Frequency, Log Scale	11Hz 07/31/2007 12:07	

3GPP W-CDMA distortion performance ^{1,2}								
			Standard		Option UN	/	Option UN with Option	
Power level			$\leq 2 \text{ dBm}^2$		$\leq 2 \text{ dBm}^2$		≤ 5 dBm²	
Offset	Configuration	Frequency	Spec	Тур	Spec	Тур	Spec	Тур
Adjacent (5 MHz)	1 DDCU 1 corrier	1800 to 2200 MHz	– 69 dBc	–73 dBc	–71 dBc	–75 dBc	–71 dBc	–75 dBc
Alternate (10 MHz)	- 1 DPCH, 1 carrier		-70 dBc	–75 dBc	–72 dBc	–77 dBc	–71 dBc	–77 dBc
Adjacent (5 MHz)	Test model 1 with	1800 to 2200 MHz	-68 dBc	-70 dBc	–71 dBc	–73 dBc	–71 dBc	–72 dBc
Alternate (10 MHz)	64 DPCH, 1 carrier			–73 dBc	–72 dBc	-76 dBc	–71 dBc	–76 dBc
Adjacent (5 MHz)	Test model 1 with	1800 to 2200 MHz	-63 dBc	-65 dBc	-65 dBc	-67 dBc	-64 dBc	-66 dBc
Alternate (10 MHz)	64 DPCH, 4 carrier		-64 dBc	-66 dBc	-66 dBc	-68 dBc	-66 dBc	-68 dBc

1. 2.

ACPR specifications apply when the instrument is maintained within ± 20 to 30 °C. This is rms power. Convert from rms to peak envelope power (PEP) with the following equation: PEP = rms power + crest factor (for example, 3GPP test model 1 with 64 DPCH has a crest factor 11.5 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11.5 dB = +16.5 dBm PEP).

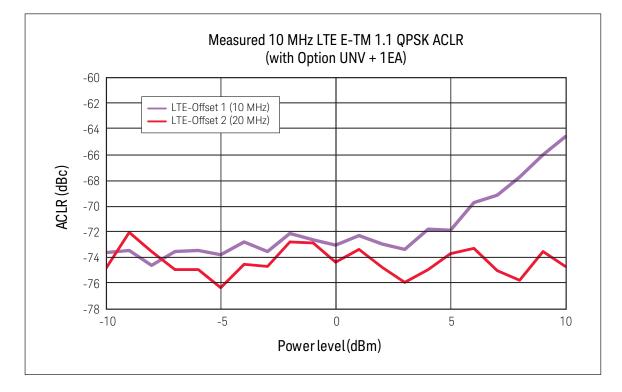


3GPP LTE-FDD distortion performance ¹								
			Standard		Option UN	/	Option UN with Option	
Power level			≤ 2 dBm²		$\leq 2 \text{ dBm}^2$		≤ 5 dBm ²	
Offset	Configuration	Frequency	Spec	Тур	Spec	Тур	Spec	Тур
Adjacent (10 MHz) ³	10 MHz E-TM 1.1	1800 to 2200 MHz	–64 dBc	-66 dBc	-67 dBc	-69 dBc	-64 dBc	-67 dBc
Alternate (20 MHz) ³	QPSK	1800 to 2200 MHZ	-66 dBc	-68 dBc	-69 dBc	–71 dBc	-69 dBc	–71 dBc

1 ACPR specifications apply when the instrument is maintained within \pm 20 to 30 °C.

This is rms power. Convert from rms to peak envelope power with the following equation: PEP = rms power + crest factor 2 (for example, 3GPP test model 1 with 64 DPCH has a crest factor 11.5 dB, therefore at +5 dBm rms, the PEP = 5 dBm + 11.5 dB = +16.5 dBm PEP). ACPR measurement configuration: reference channel integration BW: 9.015 MHz, offset channel integration bandwidth: 9.015 MHz.

З.



GSM/EDGE output RF	spectrum (ORFS)					
			GSM		EDGE	
Power level			< +7 dBm		< +7 dBm	
Offset	Configuration	Frequency ¹	Standard, typical	Option UNV, typical	Standard, typical	Option UNV, typical
200 kHz			-34 dBc	-36 dBc	-37 dBc	-38 dBc
400 kHz	1	000 to 000 MUL	-69 dBc	–70 dBc	-69 dBc	–70 dBc
600 kHz	 1 normal timeslot, bursted 	800 to 900 MHz 1800 to 1900 MHz	-81 dBc	-82 dBc	-80 dBc	-81 dBc
800 kHz	buisteu	1000 to 1900 MITIZ	-82 dBc	-83 dBc	-82 dBc	-83 dBc
1200 kHz			-84 dBc	–85 dBc	-83 dBc	-84 dBc
3GPP2 cdma2000 dis	stortion performance	, typical				
			Standard	Option UNV	Option UNV + 1EA	
Power level ²			≤2 dBm	≤ 2 dBm	≤5 dBm	
Offset	Configuration	Frequency (1)	Typical	Typical	Typical	
885 kHz to 1.98 MHz	O shared forward		–78 dBc	–79 dBc	–77 dBc	
> 1.98 to 4.0 MHz	9 channel forward - link	800 to 900 MHz	-86 dBc	-87 dBc	-87 dBc	
> 4.0 to 10 MHz			-91 dBc	-93 dBc	-93 dBc	
802.16e Mobile WiM	AX™ distortion perfo	ormance, measured				
Power	Offset ³	Configuration ⁴	Frequency	Standard, measured	UNV, measured	
< –7 dBm	10 MHz	QPSK	2.5 and 3.5 GHz	–65 dBc	-68 dBc	
Up to +5 dBm	10 MHz	QPSK	3.5 GHz	-62 dBc	–65 dBc	

1.

2.

З.

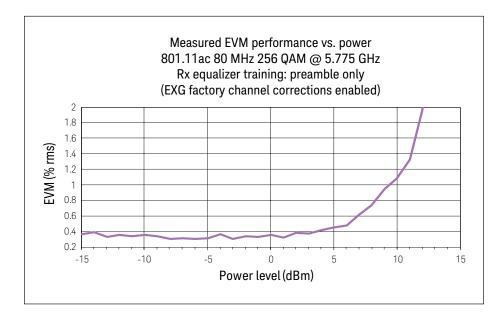
Performance evaluated at bottom, middle, and top of bands shown. This is rms power. Convert from rms to peak envelope power (PEP) with the following equation: PEP = rms power + crest factor (for example: 3GPP test model 1 with 64 DPCH has a crest factor > 11 dB, therefore at +5 dBm rms the PEP = 5 dBm + 11 dB = +16 dBm PEP). Measurement configuration: reference channel integration BW: 9.5 MHz, offset channel integration BW: 9 MHz, channel offset: 10 MHz. 802.16e WiMAX signal configuration-bandwidth: 10 MHz, FFT: 1024, frame length: 5 ms, guard period: 1/ 8, symbol rolloff: 5%, content: 30 symbols of 4. PN9 data.

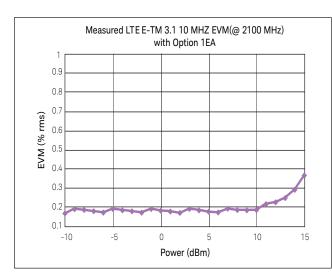
EVM performance	data ^{1,2}										
Format	GSM		EDGE		cdma200	0/IS95A	W-CDMA		LTE FDD	3	
Modulation type	GMSK (burs	ted)	3pi/8 8PSI	K (bursted)	QPSK		QPSK	QPSK		64 QAM	
Modulation rate	270.833 ks	os	70.833 ksp	DS	1.2288 Mc	ps	3.84 Mcps	S	10 MHz E	3W	
Channel configuration	1 timeslot		1 timeslot		Pilot chan	nel	1 DPCH		E-TM 3.1		
Frequency ⁴	800 to 900 1800 to 190		800 to 900 1800 to 19		800 to 900 1800 to 19		1800 to 22	200 MHz	1800 to 2	2200 MHz	
EVM power level	≤7 dBm		≤7 dBm		≤ 7 dBm		≤7 dBm		≤ 7 dBm		
EVM power level with Option 1EA	≤ 13 dBm		≤ 13 dBm		≤ 13 dBm		≤ 13 dBm		≤ 13 dBm	1	
EVM/global phase error	Spec	Туре	Spec	Туре	Spec	Туре	Spec	Туре	Measure	d	
	ms 0.8 °	0.2 °	1.2%	0.75%	1.3%	0.8%	1.2%	0.8%		0.2%	
Format	802.11a/g	802.11ac ⁵	QPSK	QPSK 16 QAM							
Modulation type	64 QAM	256 QAM	QPSK				16 QAM	16 QAM			
Modulation rate	54 Mbps	80 MHz BW	4 Msps (ro	ot-Nyquist filte	er α = 0.25)						
Frequency ⁴	2400 to 2484 MHz		≤ 3 GHz		≤ 6 GHz		≤ 3 GHz		≤ 6 GHz		
	5150 to 5825 MHz	5.775 GHz	2 3 GHZ				2 3 GHZ		2000		
EVM power level	≤ –5 dBm	≤ –5 dBm	≤4 dBm		≤4 dBm		≤ 4 dBm		≤ 4 dBm		
EVM power level with Option 1EA	≤ 2 dBm	≤2 dBm	≤ 10 dBm		≤ 10 dBm		≤ 10 dBm		≤ 10 dBm	1	
EVM	Measured	Measured	Spec	Туре	Spec	Туре	Spec	Туре	Spec	Туре	
	0.3%	0.4%	1.2%	0.8%	1.9%	1.1%	1.1%	0.65%	1.5%	0.9%	

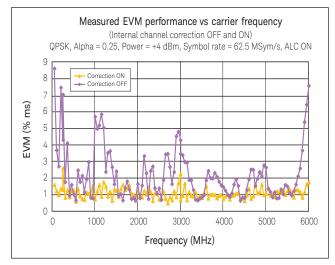
EVM specifications apply for the default ARB file setup conditions with the default ARB files supplied with the instrument. EVM specifications apply after execution of I/Q calibration when the instrument is maintained within ± 5 °C of the calibration temperature. LTE FDD E-TM 3.1,10 MHz, 64 QAM PDSCH, full resource block. Measured EVM after DC calibration.

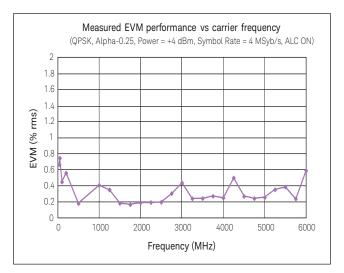
2. 3.

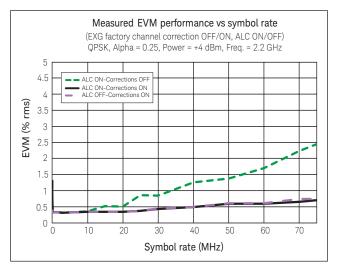
Performance evaluated at bottom, middle, and top of bands shown. WLAN 802.11ac 80 MHz, 256 QAM, MCS 8, 7 symbols, no filtering. Channel corrections enabled. Rx equalizer training: preamble only. 4. 5.











Bit error rate [BER] analyzer (Option UN7)			
Clock rate	100 Hz to 60 MHz (usable to 90 MHz)		
Data patterns	PN9, 11, 15, 20, 23		
Resolution	10 digits		
Bit sequence length100 bits to 4,294 Gbits after synchronization			
Other features	Input clock phase adjustment and gate delay Direct measurement triggering Data and reference signal outputs Real-time display Bit count Error-bit-count Bit error rate Pass/fail indication Valid data and clock detection Automatic re-synchronization Special pattern ignore		

General Specifications

Remote programming					
Interfaces	GPIB IEEE-488.2, 1987 with listen at				
	LAN 1000BaseT LAN interface, LXI Class C compliant USB Version 2.0				
Control languages	SCPI Version 1997.0				
Compatibility languages	Keysight Technologies: N5181A\61A, N 5182A\62A, N5183A, E4438C, E4428C, E442xB, E443xB, E8241A, E8244A, E8251A, E8254A, E8247C, E8257C/D, E8267C/D, 8648 Series, 8656B, E8663B, 8657A/B, 8662A, 8663A				
	Aeroflex Inc.: 3410 Series				
	Rohde & Schwarz: SMB100A, SMBV	100A, SMU200A, SMJ100A, SMATE200A, SMIQ, SML, SMV			
Power requirements					
100-120 VAC, 50/60/400 Hz 220-240 VAC, 50/60 Hz 160 W maximum (N5171B) 300 W maximum (N5172B)					
Operating temperature range					
0 to 55 °C					
Storage temperature range					
–40 to 70 °C					
Operating and storage altitude					
Up to 15,000 feet					
Humidity					
Relative humidity - type tested at 95%, +40 °	C (non-condensing)				
Environmental stress					
	d end-use; those stresses include but ar	nmental Test Manual and verified to be robust against the environ- e not limited to temperature, humidity, shock, vibration, altitude, iimilar to			
Safety					
Complies with European Low Voltage Directiv					
 IEC/EN 61010-1, 2nd Edition Canada: CSA C22.2 No. 61010-1 USA: UL std no. 61010-1, 2nd Edition German Acoustic statement 	Acoustic noise emission LpA < 70 dB Operator position Normal position Per ISO 7779	Geraeuschemission LpA < 70 dB Am Arbeitsplatz Normaler Betrieb Nach DIN 45635 t.19			
EMC					
Complies with European EMC Directive 2004	/108/EC				
 IEC/EN 61326-1 or IEC/EN 61326-2-1 CISPR Pub 11 Group 1, class A AS/NZS CISPR 11 ICES/NMB-001 					

Memory

- Memory is shared by instrument states, user data files, sweep list files, waveform sequences, and other files
- 3 GB (30 GB with Option 009) memory available in the N5172B
- Security Option 006 allows storage of up to 8 GB on SD card
- Depending on how the memory is utilized, a maximum of 1000 instrument states can be saved

Security (Option 006)

- Removable 8 GB solid state memory (SD card) from rear panel
- User can force all files to be stored only on external memory card including instrument states, user data files, sweep list files, waveforms, waveform sequences, and other files.
- Memory sanitizing, memory sanitizing on, power on, and display blanking
- Disable USB ports
- Note: Read/write speeds to external memory card will be slower compared to internal solid-state drive (Option 009)

Self-test

Internal diagnostic routines test most modules in a preset condition; for each module, if its node voltages are within acceptable limits, the module passes the test

Weight

N5171B: ≤ 13.6 kg (30 lb) net, ≤ 28.6 kg (63 lb) shipping N5172B: ≤ 15.9 kg (35 lb) net, ≤ 30.8 kg (68 lb) shipping

Dimensions

88 mm H x 426 mm W x 489 mm L (length includes rear panel feet) (3.5 in H x 16.8 in W x 19.2 in L)

Max length (L) including RF connector tip to end of rear panel feet is 508 mm (20 in)

Recommended calibration cycle

36 months

ISO compliant

This instrument is manufactured in an ISO-9001 registered facility in concurrence with Keysight Technologies' commitment to quality.

Inputs and Outputs

Front panel connectors	
RF output	Outputs the RF signal via a precision N type female connector; see output section for reverse power protection information
I and Q inputs	BNC input accepts "in-phase" and "quadrature" input signals for I/Q modulation; nominal input impedance is 50 Ω , damage levels are 1 Vrms and 5 Vpeak
USB 2.0	Used with a memory stick for transferring instrument states, licenses and other files into or out of the instrument; also used with U2000, U848X, and U202X Series USB power sensors
Rear panel connectors	
Rear panel inputs and outputs are 3.3 V	CMOS, unless indicated otherwise; CMOS inputs will accept 5 V CMOS, 3 V CMOS, or TTL voltage levels
RF output (Option 1EM)	Outputs the RF signal via a precision N type female connector
I and Q inputs (Option 1EM)	Accepts "in-phase" and "quadrature" input signals for I/Q modulation SMB connector, nominal input impedance is 50 Ω ; damage levels are 1 Vrms and 5 Vpeak; Option 1EM units will come with 2 SMB to BNC adapters
I and Q outputs	BNC outputs the analog I/Q modulation signals from the internal baseband generator; nominal output impedance 50 Ω , DC coupled; damage levels ± 2 V
I bar and Q bar outputs (Option 1EL)	BNC outputs the complement of the I and Q signals for differential applications;

Event 1	This connector outputs the programmable timing signal generated by marker 1 The marker signal can also be routed internally to control the RF blanking and ALC hold functions; this signal is also available on the AUX I/O connector With bit error rate analyzer (Option UN7) this connector is used for data input Damage levels are > +8 V and < -4 V
Pattern trigger	Accepts signal to trigger internal pattern generator to start single pattern output, for use with the internal baseband generators Accepts CMOS signal with minimum pulse width of 10 ns Female BNC Damage levels are > +8 V and < -4 V
BBTRIG 1	For arbitrary and real-time baseband generators I/O such as Markers or trigger inputs With bit error rate analyzer (Option UN7) this connector is used for clock input
BBTRIG 2	For arbitrary and real-time baseband generators I/O such as Markers or trigger inputs With bit error rate analyzer (Option UN7) this connector is used for gate input
Sweep out	Generates output voltage, 0 to +10 V when the signal generator is sweeping; this output can also be programmed to indicate when the source is settled or output pulse video and is TTL and CMOS compatible in this mode; output impedance < 1 Ω , can drive 2 k Ω ; damage levels are ± 15 V
Ext 1	External AM/FM/PM #1 input; nominal input impedance is 50 $\Omega/600~\Omega/1M~\Omega,~$ nominal; damage levels are \pm 5 V
Ext 2	External AM/FM/PM #2 input; nominal input impedance is 50 $\Omega/600~\Omega$ /1M $\Omega,~$ nominal; damage levels are \pm 5 V
LF OUT	O to 5 V peak into 50 Ω , –5 V to 5 V offset, nominal
Pulse	External pulse modulation input; this input is TTL and CMOS compatible; low logic levels are 0 V and high logic levels are +1 V; nominal input impedance is 50 Ω ; input damage levels are ≤ -0.3 V and $\geq +5.3$ V
Trigger in	Accepts TTL and CMOS level signals for triggering point-to-point in sweep mode; damage levels are \preceq -0.3 V and \geq +5.3 V
Trigger out	Outputs a TTL and CMOS compatible level signal for use with sweep mode The signal is high at start of dwell, or when waiting for point trigger in manual sweep mode, and low when dwell is over or point trigger is received This output can also be programmed to indicate when the source is settled, pulse synchronization, or pulse video Nominal output impedance 50 Ω Input damage levels are ≤ -0.3 V and $\geq +5.3$ V
Reference input	Accepts a 10 MHz reference signal used to frequency lock the internal timebase; Option 1ER adds the capability to lock to a frequency from 1 MHz to 50 MHz; nominal input level –3 to +20 dBm, impedance 50Ω , sine or square waveform
10 MHz out	Outputs the 10 MHz reference signal used by internal timebase; level nominally +3.9 dBm; nominal output impedance 50 Ω ; input damage level is +16 dBm
LO in (Option 012)	Accepts a signal from a master signal generator that is used as the LO for EXG vector in order to configure a phase coherent system; nominal input levels between 0 to +12 dBm; nominal input impedance 50 Ω
LO out (Option 012)	Outputs a reference signal that can be used in a phase coherent system; nominal output levels between 0 to +12 dBm; nominal output impedance 50 Ω
DAC Clk In (Option 012)	Reserved for future use.
Digital bus I/O	To be used with PXB or N5102A digital signal interface module

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Aux I/O	Aux I/O port sends and/or receives auxiliary signaling information: For Option UN7 this connector is used to output reference data, clock, error signals, and more Output markers to an external device from arbitrary waveform or real-time generation application such as: frame markers, pulse-per-second, even-second, and more. Input signals from external DUT to modify characteristics of a signal being generated. Such as: changing output power (power control loop testing), advancing or delaying timing (timing advance loop testing), HARQ ACK/NAK delivery (HARQ process loop testing) or streaming external data, clock and symbol synch for custom modulation. I/O is application specific (CDMA, 3GPP, GNSS, LTE, custom etc). See User Guide or Signal Studio help for more details. Connector type: 36 pin 3M connector (part number N10236-5282PC). The mating connector is a 3M 10136-3000 wire mount plug or 3M 10136-8000 IDC plug with a 3M 10336 shell. For Option 431 real-time custom modulation the follow pin numbers are assigned: Data input = pin 23 Data clock input = pin 25 Burst input = pin 25 Burst input = pin 35 Data clock output = pin 35 Data clock output = pin 37 Event 1 output = pin 37 Event 1 output = pin 33
USB 2.0	The USB connector provides remote programming functions via SCPI
LAN (1000 BaseT)	The LAN connector provides the same SCPI remote programming functionality as the GPIB connector and is also used to access the internal Web server and FTP server Supports DHCP, sockets SCPI, VXI-11 SCPI, connection monitoring, dynamic hostname services, TCP keep alive LXI class C compliant Trigger response time for the immediate LAN trigger is 0.5 ms (minimum), 4 ms (maximum), 2 ms, typical; delayed/ alarm trigger is unknown Trigger output response time is 0.5 ms (minimum), 4 ms (maximum), 2 ms, typical
GPIB	The GPIB connector provides remote programming functionality via SCPI

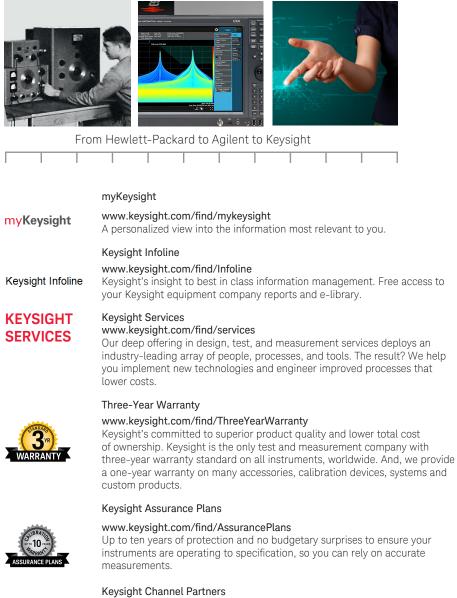
Related Literature

Keysight X-Series Signal Generators

EXG Configuration Guide	5990-9958EN
MXG Data Sheet	5991-0038EN
MXG Configuration Guide	5990-9959EN
X-Series Signal Generator Brochure	5990-9957EN
Signal Studio Software Brochure	5989-6448EN

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